

NC7ST02

TinyLogic HST 2-Input NOR Gate

Description

The NC7ST02 is a single 2-Input high performance CMOS NOR Gate, with TTL-compatible inputs. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation. ESD protection diodes inherently guard both inputs and output with respect to the V_{CC} and GND rails. High gain circuitry offers high noise immunity and reduced sensitivity to input edge rate. The TTL-compatible inputs facilitate TTL to NMOS / CMOS interfacing. Device performance is similar to MM74HCT but with $1/2$ the output current drive of HC / HCT.

Features

- Space Saving SC-74A and SC-88A 5-Lead Package
- Ultra Small MicroPak™ Leadless Package
- High Speed: $t_{PD} < 7$ ns Typ, $V_{CC} = 5$ V, $C_L = 15$ pF
- Low Quiescent Power: $I_{CC} < 1$ μ A Typ, $V_{CC} = 5.5$ V
- Balanced Output Drive: 2 mA I_{OL} , -2 mA I_{OH}
- TTL-compatible Inputs
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

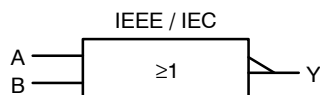


Figure 1. Logic Symbol



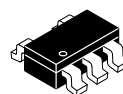
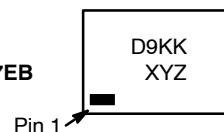
ON Semiconductor®

www.onsemi.com

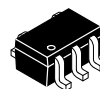
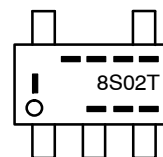
MARKING DIAGRAMS



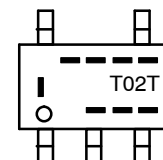
SIP6
CASE 127EB



SC-74A
CASE 318BQ



SC-88A
CASE 419A-02



D9, 8S02, T02 = Specific Device Code
KK = 2-Digit Lot Run Traceability Code
XY = 2-Digit Date Code Format
Z = Assembly Plant Code
T = Die Run Code
---- = Year Coding Scheme
I-- = Plant Code Identifier
--- = Eight-Week Datacoding Scheme

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 4 of this data sheet.

NC7ST02

Pin Configurations

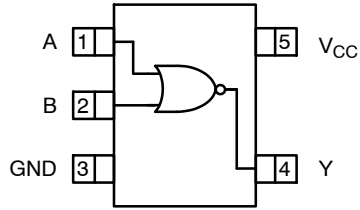


Figure 2. SC-88A and SC-74A (Top View)

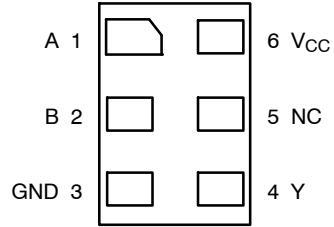


Figure 3. MicroPak (Top Through View)

PIN DESCRIPTIONS

Pin Name	Description
A, B	Inputs
Y	Output
NC	No Connect

FUNCTION TABLE ($Y = \overline{A + B}$)

Inputs		Output
A	B	Y
L	L	H
L	H	L
H	L	L
H	H	L

H = HIGH Logic Level
L = LOW Logic Level

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Min	Max	Unit
V_{CC}	Supply Voltage		-0.5	6.5	V
I_{IK}	DC Input Diode Current	$V_{IN} < -0.5\text{ V}$	-	-20	mA
		$V_{IN} \geq V_{CC} + 0.5\text{ V}$	-	+20	
V_{IN}	DC Input Voltage		-0.5	$V_{CC} + 0.5$	V
I_{OK}	DC Output Diode Current	$V_{OUT} < -0.5\text{ V}$	-	-20	mA
		$V_{OUT} > V_{CC} + 0.5\text{ V}$	-	+20	
V_{OUT}	Output Voltage		-0.5	$V_{CC} + 0.5$	V
I_{OUT}	DC Output Source or Sink Current		-	± 12.5	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current per Supply Pin		-	± 25	mA
T_{STG}	Storage Temperature		-65	+150	°C
T_J	Junction Temperature		-	+150	°C
T_L	Lead Temperature (Soldering, 10 Seconds)		-	+260	°C
P_D	Power Dissipation in Still Air	SC-74A	-	225	mW
		SC-88A	-	190	
		MicroPak	-	327	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	Supply Voltage		4.5	5.5	V
V_I	Input Voltage		0	V_{CC}	V
V_O	Output Voltage		0	V_{CC}	V
T_A	Operating Temperature		-40	+85	°C
t_r, t_f	Input Rise and Fall Time	$V_{CC} = 5.0$ V	0	500	ns
θ_{JA}	Thermal Resistance	SC-74A	–	555	°C/W
		SC-88A	–	659	
		MicroPak	–	382	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. Unused inputs must be held HIGH or LOW. They may not float.

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	Conditions	$T_A = +25^\circ\text{C}$			$T_A = -40 \text{ to } +85^\circ\text{C}$		Unit
				Min	Typ	Max	Min	Max	
V_{IH}	HIGH Level Input Voltage	4.5 – 5.5		2.0	–	–	2.0	–	V
V_{IL}	LOW Level Input Voltage	4.5 – 5.5		–	–	0.8	–	0.8	V
V_{OH}	HIGH Level Output Voltage	4.5 4.5	$I_{OH} = -20 \mu\text{A}$ $V_{IN} = V_{IL}$ $I_{OH} = -2 \text{ mA}$	4.4 4.18	4.5 4.35	–	4.4 4.13	–	V
V_{OL}	LOW Level Output Voltage	4.5 4.5	$I_{OL} = 20 \mu\text{A}$ $V_{IN} = V_{IH}$ $I_{OL} = 2 \text{ mA}$	–	0 0.10	0.1 0.26	–	0.1 0.33	V
I_{IN}	Input Leakage Current	5.5	$1.65 \leq V_{IN} \leq 5.5 \text{ V}$	–	–	± 0.1	–	± 1.0	μA
I_{CC}	Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or GND	–	–	1.0	–	10.0	μA
I_{CCT}	I_{CC} per Input	5.5	One Input $V_{IN} = 0.5 \text{ V}$ or 2.4 V, Other Input V_{CC} or GND	–	–	2.0	–	2.9	mA

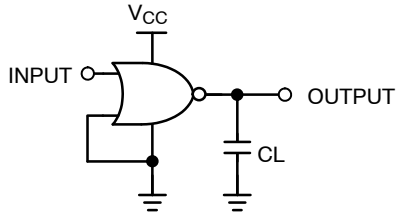
AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	Conditions	$T_A = +25^\circ\text{C}$			$T_A = -40 \text{ to } +85^\circ\text{C}$		Unit
				Min	Typ	Max	Min	Max	
t_{PLH}, t_{PHL}	Propagation Delay (Figure 4, 6)	5.0	$C_L = 15 \text{ pF}$	–	3.5	12	–	–	ns
				–	6.3	17	–	–	
		4.5	$C_L = 50 \text{ pF}$	–	6.1	16	–	20	
				–	11.7	27	–	31	
		5.5		–	4.2	14	–	18	
				–	11.4	26	–	30	
t_{TLH}, t_{THL}	Output Transition Time (Figure 4, 6)	5.0	$C_L = 15 \text{ pF}$	–	4	10	–	–	ns
		4.5	$C_L = 50 \text{ pF}$	–	11	25	–	31	
		5.5		–	10	21	–	26	
C_{IN}	Input Capacitance	Open		–	2	10	–	–	pF
C_{PD}	Power Dissipation Capacitance (Figure 5)	5.0	(Note 2)	–	6	–	–	–	pF

2. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current. Current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 5). C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CCstatic})$.

NC7ST02

AC Loading and Waveforms



C_L includes load and stray capacitance
Input PRR = 1.0 MHz; t_W = 500 ns

Figure 4. AC Test Circuit

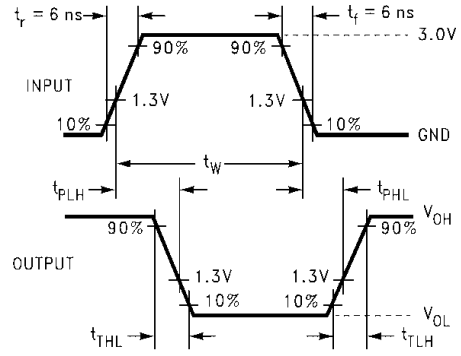
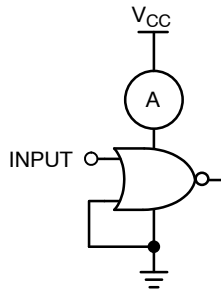


Figure 6. AC Waveforms



Input = AC Waveform;
PRR = Variable; Duty Cycle = 50%.

Figure 5. I_{CCD} Test Circuit

ORDERING INFORMATION

Order Number	Top Mark	Package Description	Shipping [†]
NC7ST02M5X	8S02	SC-74A	3000 / Tape & Reel
NC7ST02P5X	T02	SC-88A	3000 / Tape & Reel
NC7ST02L6X	D9	SIP6, MicroPak	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

2X

0.05 C

1.45

B

2X

0.05 C

1.00

(0.254)

PIN 1 IDENTIFIER

5

TOP VIEW

0.50±0.05

0.05

0.00

C

0.05 C

RECOMMENDED LAND PATTERN

(1)

(0.49)

5X

(0.52)

1X

(0.30)

6X

PIN 1

DETAIL A

1.45±0.05

1.0

0.20±0.05 6X

0.10(M) C B A

0.05(M) C

0.30±0.05 5X

1.00±0.05

0.35±0.05 5X

(0.050) 6X

0.5

(0.125) 4X

BOTTOM VIEW

0.35±0.05

0.40±0.05

0.075 X 45° CHAMFER

DETAIL A

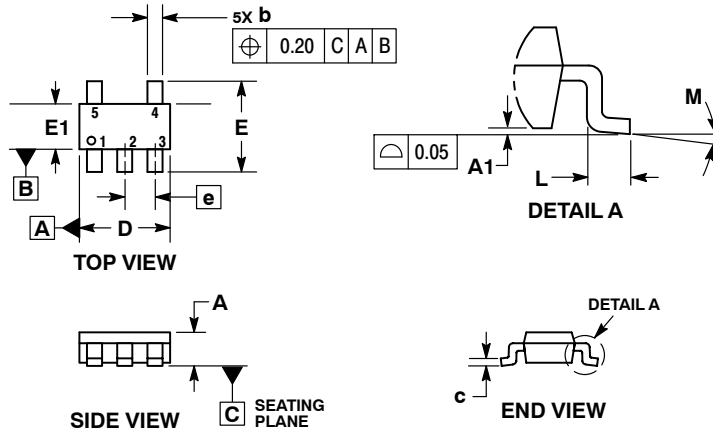
PIN 1 TERMINAL

1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-2009
4. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY OTHER LINE IN THE MARK CODE LAYOUT.

NC7ST02

PACKAGE DIMENSIONS

SC-74A CASE 318BQ ISSUE B

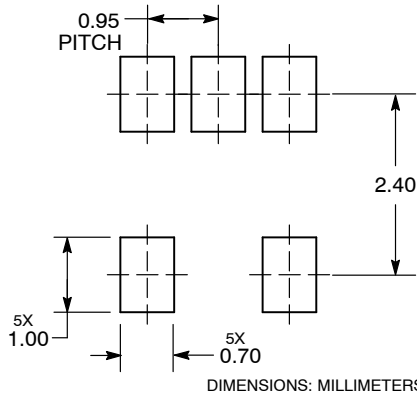


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

DIM	MILLIMETERS	
	MIN	MAX
A	0.90	1.10
A1	0.01	0.10
b	0.25	0.50
c	0.10	0.26
D	2.85	3.15
E	2.50	3.00
E1	1.35	1.65
e	0.95 BSC	
L	0.20	0.60
M	0°	10°

RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

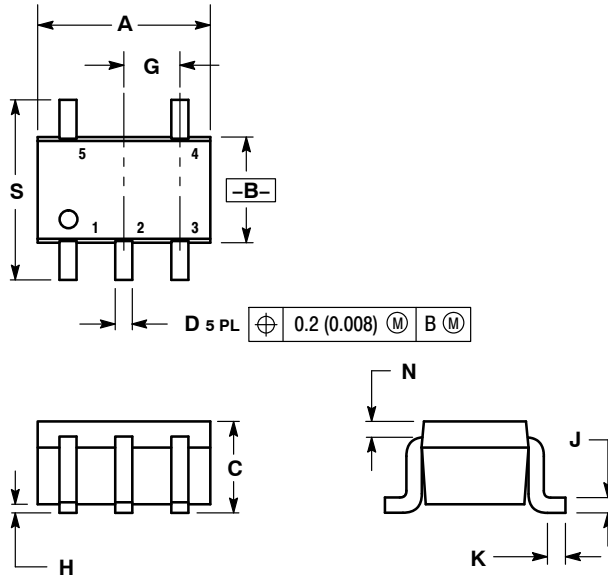
NC7ST02

PACKAGE DIMENSIONS

SC-88A (SC-70-5/SOT-353)

CASE 419A-02

ISSUE L

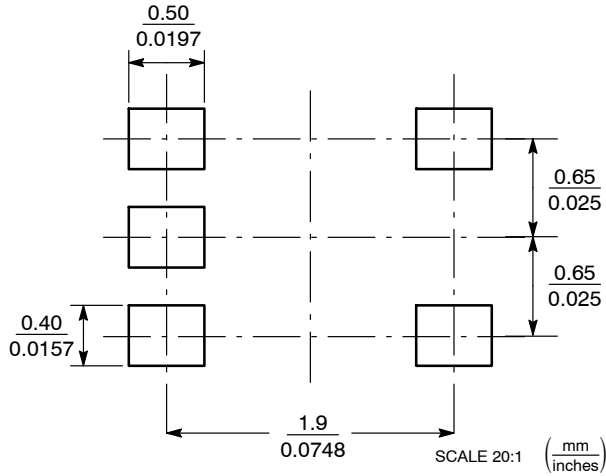


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419A-01 OBSOLETE. NEW STANDARD 419A-02.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.071	0.087	1.80	2.20
B	0.045	0.053	1.15	1.35
C	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026 BSC		0.65 BSC	
H	---	0.004	---	0.10
J	0.004	0.010	0.10	0.25
K	0.004	0.012	0.10	0.30
N	0.008 REF		0.20 REF	
S	0.079	0.087	2.00	2.20

SOLDER FOOTPRINT



STYLE 1:

- PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 2:

- PIN 1. ANODE
2. EMITTER
3. BASE
4. COLLECTOR
5. CATHODE

STYLE 3:

- PIN 1. ANODE 1
2. N/C
3. ANODE 2
4. CATHODE 2
5. CATHODE 1

STYLE 4:

- PIN 1. SOURCE 1
2. DRAIN 1/2
3. SOURCE 1
4. GATE 1
5. GATE 2

STYLE 5:

- PIN 1. CATHODE
2. COMMON ANODE
3. CATHODE 2
4. CATHODE 3
5. CATHODE 4

STYLE 6:

- PIN 1. EMITTER 2
2. BASE 2
3. EMITTER 1
4. COLLECTOR
5. COLLECTOR 2/BASE 1

STYLE 7:

- PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 8:

- PIN 1. CATHODE
2. COLLECTOR
3. N/C
4. BASE
5. EMITTER

STYLE 9:

- PIN 1. ANODE
2. CATHODE
3. ANODE
4. ANODE
5. ANODE

MicroPak is trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910

ON Semiconductor Website: www.onsemi.com
Order Literature: <http://www.onsemi.com/orderlit>
For additional information, please contact your local Sales Representative